TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

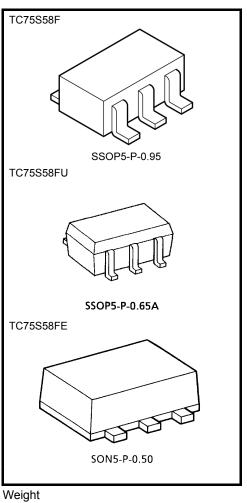
# TC75S58F, TC75S58FU, TC75S58FE

#### Single Comparator

The TC75S58F/TC75S58FU/TC75S58FE is a CMOS generalpurpose single comparator. The device can operate off a single power supply and draws a lower supply current than a conventional bipolar general-purpose comparator. This device's open-drain output stage can be wire-ORed with those of other open-drain output circuits.

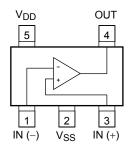
#### Features

- Low-current power supply
- $: I_{DD} = 10 \ \mu A \ (typ.)$
- Single power supply operation
- Wide common mode input voltage range : VSS to VDD 0.9 V
- Open drain output circuit
- Low input bias current
- Small package



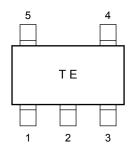
SSOP5-P-0.95 : 0.014 g (typ.) SSOP5-P-0.65A : 0.006 g (typ.) SON5-P-0.50 : 0.003 g (typ.)

### Pin Connection (top view)



Start of commercial production 1997-02

#### Marking (top view)



### Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Supply voltage		V <sub>DD</sub> , V <sub>SS</sub>	±3.5 or 7	V	
Differential input voltage		DVIN	±7	V	
Input voltage		V <sub>IN</sub>	$V_{\mbox{\scriptsize SS}}$ to $V_{\mbox{\scriptsize DD}}$	V	
Output current		Ι <sub>Ο</sub>	±35	mA	
Power dissipation	TC75S58F/FU	D-	200	mW	
	TC75S58FE	PD	100	IIIVV	
Operating temperature		T <sub>opr</sub>	-40 to 85	°C	
Storage temperature		T <sub>stg</sub>	-55 to 125	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: This device's CMOS structure makes it prone to latch-up. To prevent latch-up, please take the following precautions:

- Ensure that no I/O pin's voltage level ever exceeds V<sub>DD</sub> or drops below V<sub>SS</sub>. In addition, check the power-on timing.
- Do not subject the device to excessive noise.

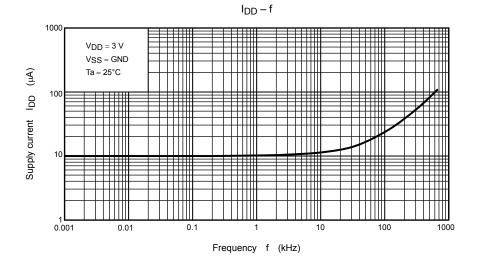
### Electrical Characteristics ( $V_{DD} = 5 V$ , $V_{SS} = GND$ , $Ta = 25^{\circ}C$ )

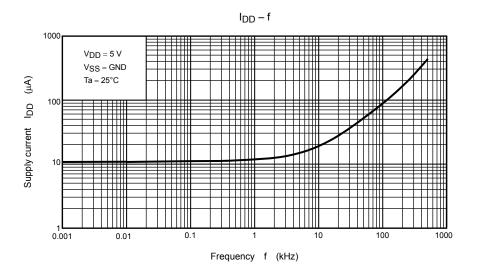
Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input offset voltage	V <sub>IO</sub>		—		±1	±7	mV
Input offset current	l <sub>IO</sub>	_	_		1	_	pА
Input bias current	lj	_	—	_	1	_	pА
Common mode input voltage	CMVIN	_	—	0	_	4.1	V
Supply current	I <sub>DD</sub> (Note)		_		11	22	μA
Voltage gain	GV		_		94	_	dB
Sink current	l <sub>sink</sub>		V <sub>OL</sub> = 0.5 V	13	25	_	mA
Output leak current	ILEAK		$V_0 = 5 V$		5	_	nA
Output voltage	V <sub>OL</sub>		I <sub>sink</sub> = 5.0 mA		0.1	0.3	V
Operating supply voltage	V <sub>DD</sub>	_	—	1.8	_	7.0	V
Propagation delay time (turn on)	<sup>t</sup> PLH (1)	_	Over drive = 100 mV		800	_	ns
	t <sub>PLH</sub> (2)		TTL step input		620	_	
Propagation delay time (turn off)	<sup>t</sup> PHL (1)		Over drive = 100 mV		230	_	ns
	t <sub>PHL</sub> (2)		TTL step input		350		
Response time	t <sub>TLH</sub>		Over drive = 100 mV		190	_	ns
	t <sub>THL</sub>		Over drive = 100 mV		6		

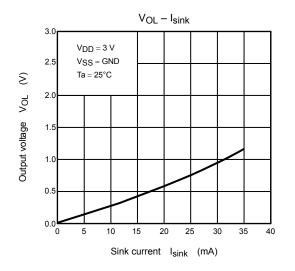
### Electrical Characteristics ( $V_{DD} = 3 V$ , $V_{SS} = GND$ , $Ta = 25^{\circ}C$ )

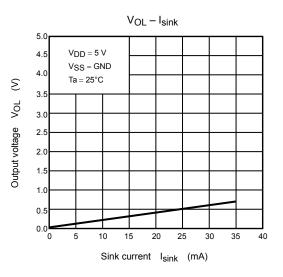
Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input offset voltage	V <sub>IO</sub>		—	_	±1	±7	mV
Input offset current	l <sub>IO</sub>		—	_	1	_	pА
Input bias current	lı		—	_	1	_	pА
Common mode input voltage	CMVIN		—	0	_	2.1	V
Supply current	I <sub>DD</sub> (Note)		—	_	10	20	μA
Sink current	I <sub>sink</sub>		V <sub>OL</sub> = 0.5 V	6	18	_	mA
Output leak current	I <sub>LEAK</sub>	_	$V_0 = 3 V$	_	5	_	nA
Output voltage	V <sub>OL</sub>	_	I <sub>sink</sub> = 5.0 mA	_	0.15	0.35	V
Propagation delay time (turn on)	t <sub>PLH</sub>	_	Over drive = 100 mV	_	590	_	ns
Propagation delay time (turn off)	t <sub>PHL</sub>		Over drive = 100 mV		230		ns
Response time	tтLH		Over drive = 100 mV	_	170	_	20
	t <sub>THL</sub>		Over drive = 100 mV		5		ns

Note: This device's current consumption increases as its operating frequency increases. Note that the power dissipation should not exceed the allowable power dissipation.

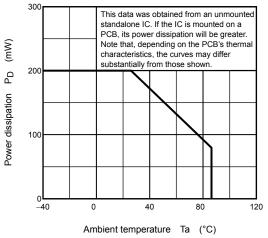








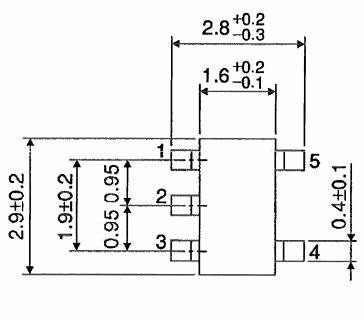


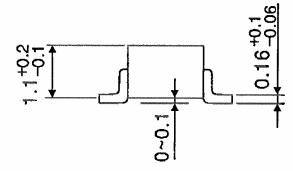


### **Package Dimensions**

SSOP5-P-0.95

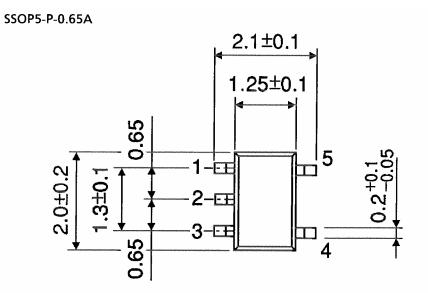
Unit : mm

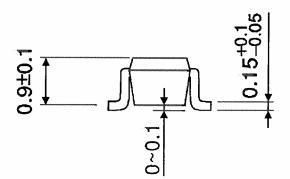




Weight: 0.014 g (typ.)

### **Package Dimensions**





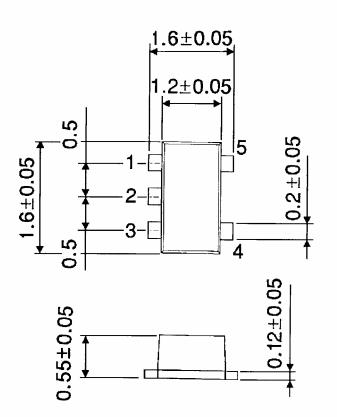
Weight: 0.006 g (typ.)

Unit : mm

### Package Dimensions

SON5-P-0.50

Unit : mm



Weight: 0.003 g (typ.)

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